74LVT244B-Q100

3.3 V octal buffer/line driver; 3-state

Rev. 1 — 1 November 2023

Product data sheet

1. General description

The 74LVT244B-Q100 is an 8-bit buffer/line driver with 3-state outputs. The device can be used as two 4-bit buffers or one 8-bit buffer. The device features two output enables $(1\overline{OE} \text{ and } 2\overline{OE})$, each controlling four of the 3-state outputs. A HIGH on $n\overline{OE}$ causes the outputs to assume a high-impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
 - Specified from -40 °C to +85 °C
- · Octal bus interface
- 3-state buffers
- Speed upgrade of 74LVT244A
- Wide supply voltage range from 2.7 to 3.6 V
- · BiCMOS high speed and output drive
- Output capability: +64 mA and -32 mA
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Input and output interface capability to systems at 5 V supply
- No bus current loading when output is tied to 5 V bus
- Power-up 3-state
- Live insertion and extraction permitted
- I_{OFF} circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- Complies with JEDEC standards
 - JESD8C (2.7 V to 3.6 V)
- ESD protection:
 - HBM EIA/JESD22-A114-C exceeds 2000 V
 - MM EIA/JESD22-A115-A 200 V

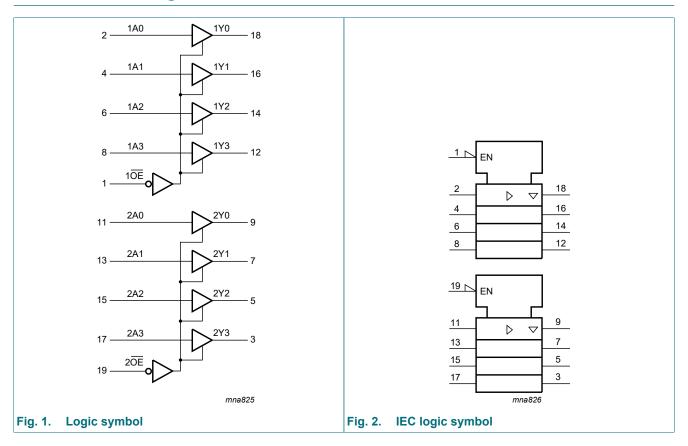
3. Ordering information

Table 1. Ordering information

Type number	Package	ackage										
	Temperature range	Name	Description	Version								
74LVT244BPW-Q100	-40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1								

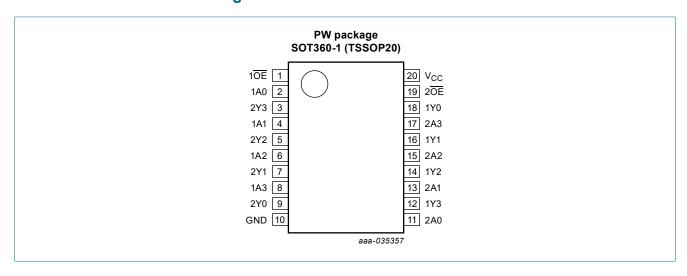


4. Functional diagram



5. Pinning information

5.1. Pinning



2/11

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1 OE , 2 OE	1, 19	output enable input (active low)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2Y0, 2Y1, 2Y2, 2Y3	9, 7, 5, 3	data output
GND	10	ground (0 V)
2A0, 2A1, 2A2, 2A3	11, 13, 15, 17	data input
1Y0, 1Y1, 1Y2, 1Y3	18, 16, 14, 12	data output
V _{CC}	20	supply voltage

6. Functional description

Table 3. Function table

 $H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; X = don't care; Z = high-impedance OFF-state.}$

	Input	Output
nŌE	nAn	nYn
L	L	L
L	Н	Н
Н	X	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
VI	input voltage		[1]	-0.5	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state	[1]	-0.5	+7.0	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
I _{OK}	output clamping current	V _O < 0 V		-50	-	mA
Io	output current	output in LOW-state		-	128	mA
		output in HIGH-state		-64	-	mA
T _{stg}	storage temperature			-65	+150	°C
Tj	junction temperature		[2]	-	150	°C
P _{tot}	total power dissipation	T _{amb} = -40 to +85 °C		-	500	mW

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

^[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

8. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.7	-	3.6	V
VI	input voltage		0	-	5.5	V
I _{OH}	HIGH-level output current		-32	-	-	mA
I _{OL}	LOW-level output current	none	-	-	32	mA
		current duty cycle ≤ 50 %; f _i ≥ 1 kHz	-	-	64	mA
T _{amb}	ambient temperature	in free-air	-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	outputs enabled	-	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T _{amb} = -4	40 °C to +85 °C			'		
V _{IK}	input clamping voltage	V _{CC} = 2.7 V; I _{IK} = -18 mA	-1.2	-0.9	-	V
V _{IH}	HIGH-level input voltage		2.0	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.8	V
V _{OH}	HIGH-level output voltage	V _{CC} = 2.7 V; I _{OH} = -100 μA	V _{CC} - 2.0	V _{CC} - 2.1	-	V
		V _{CC} = 2.7 V; I _{OH} = -8 mA	2.4	2.5	-	V
		V _{CC} = 3.0 V; I _{OH} = -32 mA	2.0	2.2	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 2.7 V; I _{OL} = 100 μA	-	0.1	0.2	V
		V _{CC} = 2.7 V; I _{OL} = 24 mA	-	0.3	0.5	V
		V _{CC} = 3.0 V; I _{OL} = 16 mA	-	0.25	0.4	V
		V _{CC} = 3.0 V; I _{OL} = 32 mA	-	0.3	0.5	V
		V _{CC} = 3.0 V; I _{OL} = 64 mA	-	0.4	0.55	V
I _I	input leakage current	all input pins				
		V _{CC} = 0 V or 3.6 V; V _I = 5.5 V	-	0.1	10	μΑ
		control pins				
		V_{CC} = 3.6 V; V_{I} = V_{CC} or GND	-1	±0.1	1	μΑ
		data pins [2]				
		V _{CC} = 3.6 V; V _I = V _{CC}	-	0.1	1	μΑ
		V _{CC} = 3.6 V; V _I = 0 V	-5	-1	-	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ V to } 4.5 \text{ V}$	-100	1	+100	μA
I _{BHL}	bus hold LOW current	V _{CC} = 3 V; V _I = 0.8 V	75	130	-	μΑ
I _{BHH}	bus hold HIGH current	V _{CC} = 3 V; V _I = 2.0 V	-	-140	-75	μA
I _{BHLO}	bus hold LOW overdrive current	$V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V to } 3.6 \text{ V}$ [3]	500	-	-	μΑ
Івнно	bus hold HIGH overdrive current	$V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V to } 3.6 \text{ V}$	-	-	-500	μΑ
I _{EX}	external current	nYn output in HIGH-state when V _O > V _{CC} ; V _O = 5.5 V; V _{CC} = 3.3 V	-	60	125	μΑ

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
I _{O(pu/pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ $V_I = \text{GND or } V_{CC}; n\overline{\text{OE}} = \text{don't care}$	[4]	-100	±1	+100	μA
l _{OZ}	OFF-state output current	V_{CC} = 3.6 V; V_I = V_{IH} or V_{IL}					
		V _O = 3.0 V		-	1	5	μΑ
		V _O = 0.5 V		-5	-1	-	μA
I _{CC} s	supply current	$V_{CC} = 3.6 \text{ V}; V_{I} = \text{GND or } V_{CC}; I_{O} = 0 \text{ A}$					
		output HIGH		-	0.13	0.19	mA
		output LOW		-	2	5	mA
		outputs disabled	[5]	-	0.13	0.19	mA
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 3.0 V to 3.6 V; one input at V_{CC} - 0.6 V and other inputs at V_{CC} or GND	[6]	-	0.1	0.2	mA
Cı	input capacitance	V _I = 0 V or 3.0 V		-	4	-	pF
Co	output capacitance	outputs disabled; V _O = 0 V or 3.0 V		-	8	-	pF

- [1] Typical values are measured at T_{amb} = 25 °C.
- [2] Unused pins at V_{CC} or GND.
- [3] This is the bus hold overdrive current required to force the input to the opposite logic state.
- [4] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From V_{CC} = 1.2 V to V_{CC} = 3.3 V ± 0.3 V a transition time of 100 μ s is permitted. This parameter is valid for T_{amb} = 25 °C only.
- [5] I_{CC} is measured with outputs pulled to V_{CC} or GND.
- [6] This is the increase in supply current for each input at V_{CC} 0.6 V.

10. Dynamic characteristics

Table 7. Dynamic characteristics

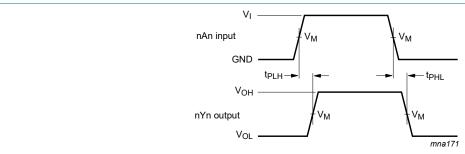
Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T _{amb} = -4	40 °C to +85 °C					
t _{PLH}	LOW to HIGH	nAn to nYn; see Fig. 3				
	propagation delay	V _{CC} = 2.7 V	-	-	3.8	ns
		V _{CC} = 3.0 V to 3.6 V	1.1	1.9	3.5	ns
t _{PHL}	HIGH to LOW	nAn to nYn; see Fig. 3				
I	propagation delay	V _{CC} = 2.7 V	-	-	3.6	ns
		V _{CC} = 3.0 V to 3.6 V	1.3	2.0	3.3	ns
t _{PZH}	OFF-state to HIGH	nOE to nYn; see Fig. 4				
	propagation delay	V _{CC} = 2.7 V	-	-	5.3	ns
		V _{CC} = 3.0 V to 3.6 V	1.1	2.8	4.5	ns
t _{PZL}	OFF-state to LOW	nOE to nYn; see Fig. 4				
	propagation delay	V _{CC} = 2.7 V	-	-	4.9	ns
		V _{CC} = 3.0 V to 3.6 V	1.4	2.3	4.4	ns

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
t _{PHZ} HIGH to OFF-state		nOE to nYn; see Fig. 4				
	propagation delay	V _{CC} = 2.7 V	-	-	4.5	ns
		V _{CC} = 3.0 V to 3.6 V	1.9	2.9	4.4	ns
t _{PLZ}	LOW to OFF-state	nOE to nYn; see Fig. 4				
	propagation delay	V _{CC} = 2.7 V	-	-	4.4	ns
		V _{CC} = 3.0 V to 3.6 V	1.8	2.5	4.4	ns

^[1] Typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

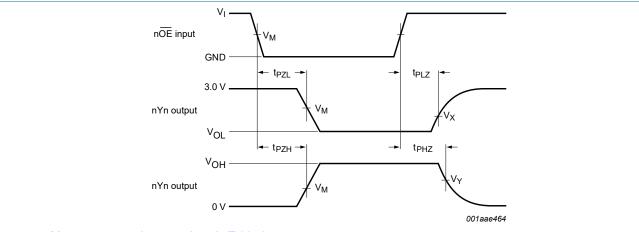
10.1. Waveforms and test circuit



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 3. Propagation delay input (nAn) to output (nYn)



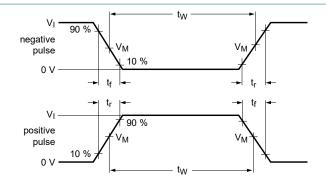
Measurement points are given in Table 8.

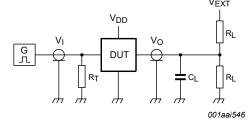
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 4. 3-state output enable and disable times

Table 8. Measurement points

Input	Output		
V_{M}	V _M	V _X	V_{Y}
1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V





Test data is given in Table 9.

Definitions test circuit:

R_L = Load resistance;

C_L = Load capacitance including jig and probe capacitance;

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;

 V_{EXT} = Test voltage for switching times.

Fig. 5. Test circuit for measuring switching times

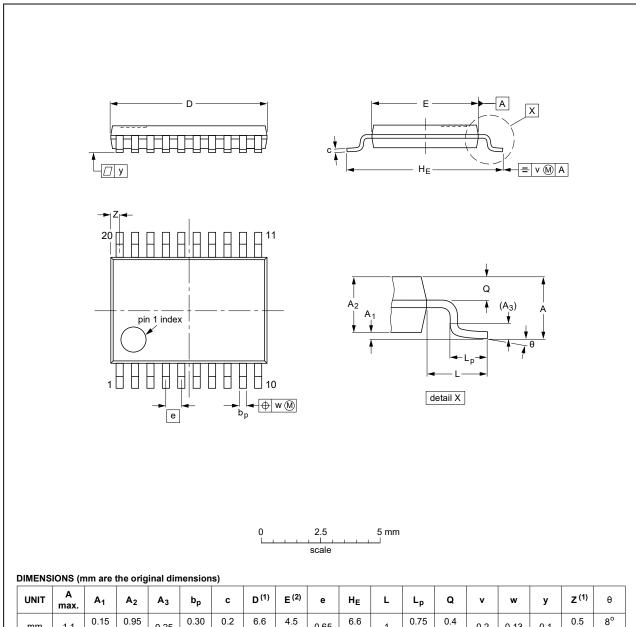
Table 9. Test data

Input				Load		V _{EXT}			
VI	fi	t _W	t _r , t _f	CL	R_L	t _{PHZ} , t _{PZH}	t_{PLZ}, t_{PZL}	t _{PLH} , t _{PHL}	
2.7 V	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V	open	

11. Package outline

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT360-1		MO-153				99-12-27 03-02-19

Fig. 6. Package outline SOT360-1 (TSSOP20)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description	
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVT244B_Q100 v.1	20231101	Product data sheet	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications — This Nexperia product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or

equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own triple.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nexperia.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Contents

1. General description	1
2. Features and benefits	1
3. Ordering information	1
4. Functional diagram	2
5. Pinning information	2
5.1. Pinning	2
5.2. Pin description	3
6. Functional description	3
7. Limiting values	3
8. Recommended operating conditions	4
9. Static characteristics	4
10. Dynamic characteristics	5
10.1. Waveforms and test circuit	6
11. Package outline	8
12. Abbreviations	9
13. Revision history	9
14. Legal information	

For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 1 November 2023

11 / 11

[©] Nexperia B.V. 2023. All rights reserved